

# KL8171

## PHOTO TRANSISTOR

### 4PIN 晶体管光耦

提供隔离反馈，逻辑电路之间的接口，带基极引脚高可靠输出光耦

\* 本文档中包含的信息反映了具有代表性的使用场景，仅供技术参考。

The information contained in this document reflects representative usage scenarios and is intended for technical reference only.

\* 本文档中提到的产品型号和规格如有更改或改进，恕不另行通知。在生产使用之前，客户应参考产品规格书的最新数据表。

Product models and specifications mentioned in this document are subject to change or improvement without notice. Customers should refer to the latest data sheets in the product specifications prior to production use.

\* 在使用本文档中引用的产品时，请确保产品在数据手册中规定的环境和电气限制范围内运行。如果客户使用超过指定的限制，晶台将不会对任何后续问题负责。

When using the products referenced in this document, ensure that the products are operated within the environmental and electrical limits specified in the data sheet. If the customer uses the product beyond the specified limits, Kinglight will not be responsible for any subsequent problems.

\* 本文档中的信息适用于电子元器件应用中的典型用法。如有任何特殊用途，请向晶台咨询，以获得进一步的帮助。

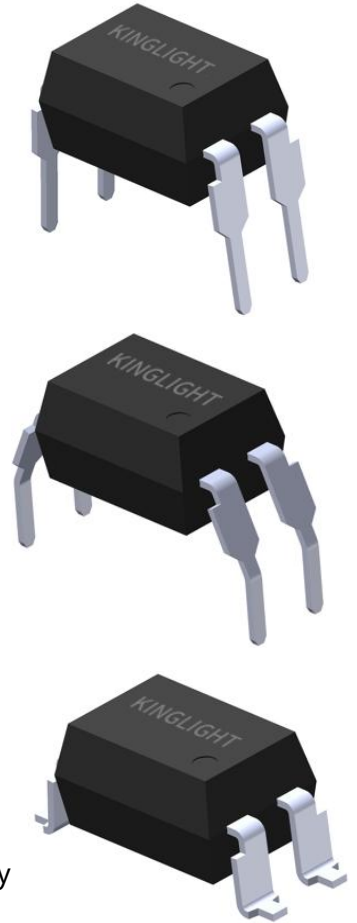
The information in this document applies to typical use in electronic component applications. For special applications, please contact Kinglight for further assistance.

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## 1. 产品特点 Product features

- 电流转换率(Current transfer ratio)  
CTR: 100~350% at  $I_F = 0.5\text{mA}$ ,  $V_{CE} = 5\text{V}$
- 输入与输出高隔离电压( $V_{iso} = 5000\text{ V rms}$ )  
High isolation voltage between inputs and output ( $V_{iso} = 5000\text{ V rms}$ )
- 爬电距离大于7.62mm  
Creepage distance  $> 7.62\text{mm}$
- 工作温度可达+100°C  
Operating temperature up to  $+100^\circ\text{C}$
- 4PIN引脚封装模式  
4PIN DIP encapsulation mode
- 符合无卤素(溴 $< 900\text{ppm}$ , 氯 $< 900\text{ppm}$ , 溴+氯 $< 1500\text{ppm}$ )  
Compliance Halogen Free (Br  $< 900\text{ppm}$ , Cl  $< 900\text{ppm}$ , Br+Cl  $< 1500\text{ppm}$ )
- CQC认证已批准(编号:CQC23001407997)  
CQC approved (No. CQC23001407997)



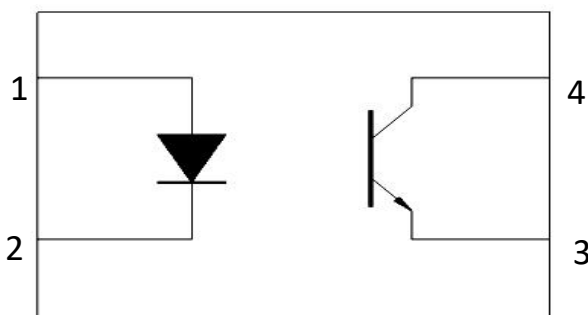
## 2. 产品描述 Product Description

- KL8171光耦合器由一个红外发射二极管, 光耦合到光电晶体管构成  
KL8171 series of devices each consist of an infrared emitting diodes, optically coupled to a phototransistor detector with green compound
- 它们采用4引脚DIP封装, 并提供宽引线间距和SMD选项  
Packaged in a 4-pin DIP package and available in wide-lead spacing and SMD option

## 3. 产品应用 Product Applications

- 系统电器、测量仪器 System appliances, measuring instruments
- 可编程序控制器 Programmable controllers
- 家用电器, 如风扇加热器等 Home appliances, such as fan heaters, etc.
- 电信设备 Telecommunication equipments
- 不同电位,不同阻抗的电路之间的信号传输 Signal transmission between circuits of different potentials and impedances

## 4. 功能图 Functional Diagram



引脚配置 Pin Configuration

1. 阳极Anode
2. 阴极Cathode
3. 发射极Emitter
4. 集电极Collector

## 5. 光电特性 Electrical-Optical characteristics

• 最大限度额定值(温度=25±5°C) Absolute Maximum Ratings(Ta=25°C)

参数 Parameter		符号 Symbol	额定值 Rated Value	单位 Unit
输入 Input	正向电流 Forward current	$I_F$	10	mA
	反向电压 Reverse voltage	$V_R$	6	V
	功耗 Power dissipation	$P_D$	20	mW
输出 Output	功耗 Power dissipation	$P_C$	150	mW
	集电极电流 Collector current	$I_C$	50	mA
	集电极发射极电压 Collector-Emitter voltage	$V_{CEO}$	70	V
	发射极-集电极电压 Emitter-Collector voltage	$V_{ECO}$	6	V
总消耗功率 Total Consume Power		$P_{TOT}$	170	mW
隔离电压 (1*) Isolation Voltage		$V_{iso}$	5000	Vrms
工作温度 Operating temperature		$T_{OPR}$	-30 to +100	°C
储存温度 Storage temperature		$T_{STG}$	-55 to +125	°C
焊接温度 (2*) Soldering temperature		$T_{SOL}$	260	°C

1\* a.1个交流电源1分钟内,相对湿度在40~60%环境下,隔离电压测试方法如下

Within 1 minute of 1 AC power supply, the relative humidity is in 40~60% environment, and the isolation voltage test method is as follows

b.引脚1&2短接在一起,引脚3&4短接在一起

Pins 1 & 2 are short together and pins 3 & 4 are connected together

2\* 焊接时间为10秒 Soldering time is 10 seconds

## 6. 电气特性(Ta=25°C,除非另有规定)

## Electrical Characteristics(Ta=25°C unless specified otherwise)

参数 Parameter		符号 Symbol	最小值 Min.	规格值 Typ.	最大值 Max.	单位 Unit	条件 Condition
输入 In put	正向电压 Forward voltage	$V_F$	-	1.2	1.4	V	$I_F=10\text{mA}$
	反向电流 Reverse current	$I_R$	-	-	10	$\mu\text{A}$	$V_R=4\text{V}$
	输入电容 Input capacitance	$C_{in}$	-	-	250	pF	$V=0, f=1\text{kHz}$
输出 Out put	集电极与发射极间暗电流 Collector-Emitter dark current	$I_{CEO}$	-	-	100	nA	$V_{CE}=20\text{V}$ $I_F=0\text{mA}$
	集电极与发射极间击穿电压 Collector-Emitter breakdown voltage	$BV_{CEO}$	70	-	-	V	$I_C=0.1\text{mA}$ $I_F=0\text{mA}$
	发射极与集电极间击穿电压 Emitter-Collector breakdown voltage	$BV_{ECO}$	6	-	-	V	$I_E=0.1\text{mA}$ $I_F=0\text{mA}$
传输特性 Transfer Characteristics	集电极与发射极间饱和电压 Collector-Emitter saturation voltage	$V_{CE(sat)}$	-	-	0.2	V	$I_F=10\text{mA}$ $I_C=1\text{mA}$
	电流传输比 Current transfer ratio(1*)	CTR	100	-	350	%	$I_F=0.5\text{mA}$ $V_{CE}=5\text{V}$
	隔离电阻 Isolation resistance	$R_{IO}$	$5 \times 10^{10}$	-	-	W	$V_{IO}=500\text{Vdc}$ 40~60% R.H.
	浮动电容 Floating capacitance	$C_{IO}$	-	-	1.0	pF	$V_{IO}=0, f=1\text{MHz}$
	截止频率 Cut-off frequency	$f_c$	-	80	-	kHz	$V_{CE}=5\text{V}$ , $I_C=2\text{mA}$ $R_L=100\Omega, -3\text{dB}$
	上升时间 Rise time	$t_r$	-	-	18	$\mu\text{s}$	$V_{CE}=2\text{V}$ , $I_C=2\text{mA}$ ,
	下降时间 Fall time	$t_f$	-	-	18	$\mu\text{s}$	$R_L=100\Omega$

• 温度Ta=25°C下规格值 Typical values at Ta = 25°C

## 7. 可靠性试验 Reliability Test

序号 NO.	试验项目 Test Items	参考标准 Reference	试验条件 Test conditions	试验过程 Test process	试验数 Qty.(pcs)	允收水准 LTPD
1	温度循环 TC	JESD22-A104C	H:125±5°C 15min J5min L:-55±5°C 15min	300cycle	45	0/45
2	高温操作寿命 HTOL	JESD22-A108C	HTOL@110°±5C IF=10mA Ic=10mA	168、500、 1000hrs	45	0/45
3	高温反向偏压 HTRB	JESD22-A108C	HTRB@125±5°C Vce=60V	168、500、 1000hrs	45	0/45
4	温湿度反向偏 压寿命试验 H3TRB	JESD22-A101- B	H3TRB@ 85±5°C、 85±5%RH Vce=60V	168、500、 1000hrs	45	0/45
5	压力锅 Autoclave	JESD22-A102- C	Ta=121±5°C, 100±5%RH, 2atm	96hrs	45	0/45
6	高温储存 HTS	JESD22-A103C	HTS@125±5°C	168、500、 1000hrs	45	0/45
7	低温储存 LTS	JESD22-A119	LTS@-55±5°C	168、500、 1000hrs	45	0/45
8	耐锡热试验 RSH	JESD22-B106C	RSH@260±5°C	10sec*3times	22	0/22
9	可焊性 SD	JESD22-B102D	Pb-free@ 245±5°C	3sec*1times	22	0/22
备注 Remarks	<p>以上试验项目如与客户试验要求存在差异或者特殊客户特殊要求的,可根据实际情况按照客户的要求进行试作,客户未要求依我司试验标准试作,不同产品使用不同电流进行测试</p> <p>All the tests should be performed according to customers' actual requirements, while difference of test standard or special requirements exist. Otherwise, all the tests are performed according to the standard listed above. Different current is applied to the tests of different product models</p>					

### 8. 特性曲线 Characteristic Curves

图1 正向电流与正向电压的关系

Fig.1 Forward Current vs Forward Voltage

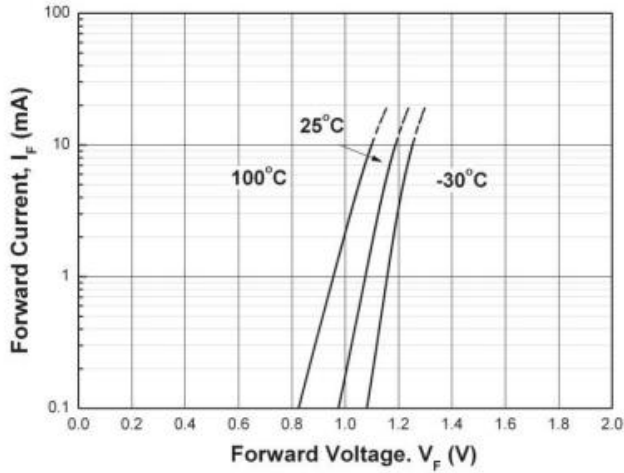


图3 电流传输比与环境温度的关系

Fig.3 Current Transfer Ratio vs Ambient Temperature

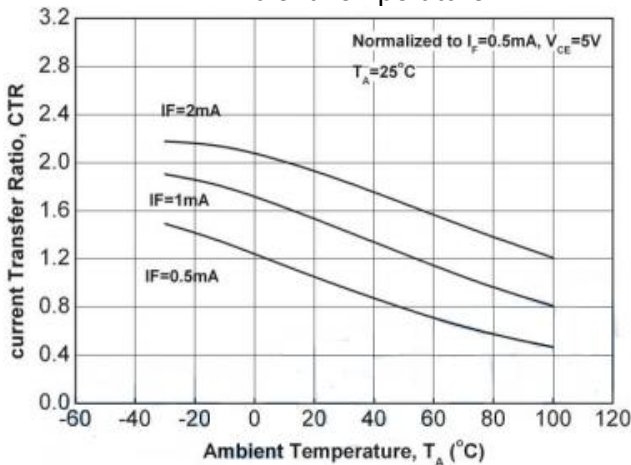


图5 集电极电流与集电极发射极电压的关系

Fig.5 Collector Current vs Collector Emitter Voltage

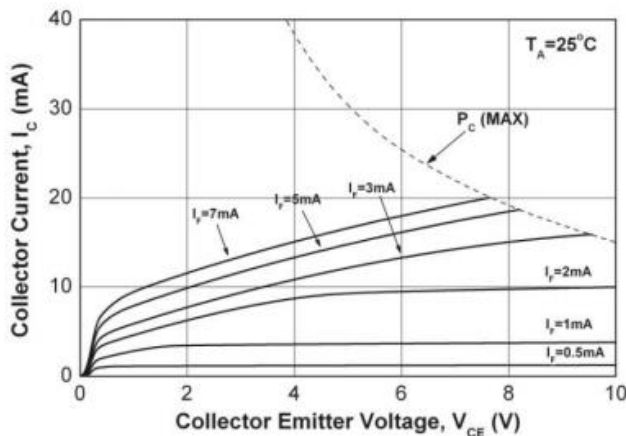


图2 电流传输比与正向电流的关系

Fig.2 Normalized Current Transfer Ratio vs Forward Current

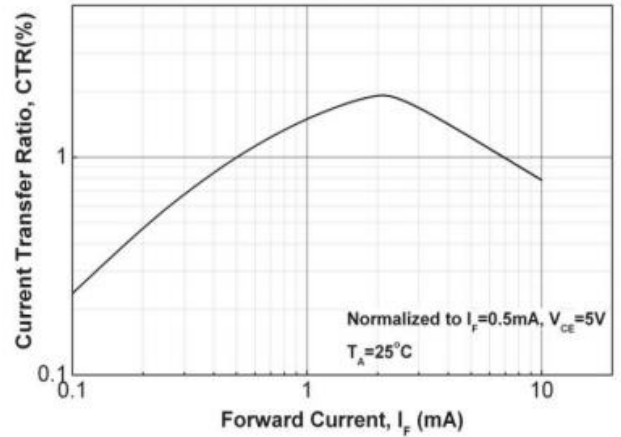


图4 暗电流与环境温度的关系

Fig.4 Dark Current vs Ambient Temperature

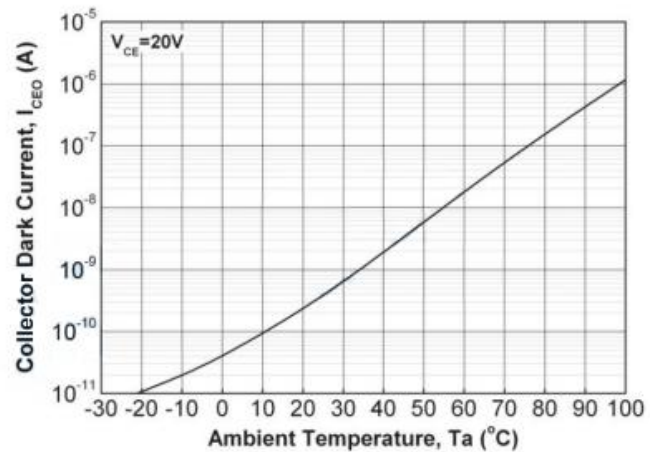


图6 开关时间与负载电阻的关系

Fig.6 Switching Time vs Load Resistance

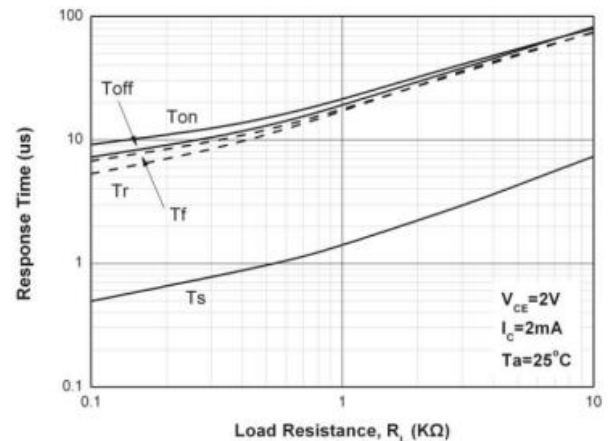
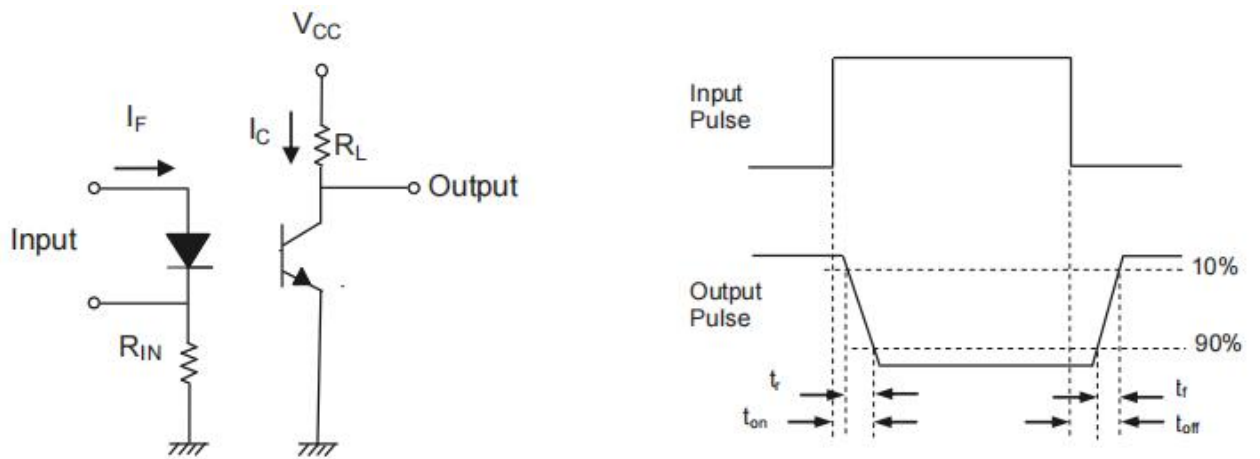


图7 开关时间测试电路及波形  
Figure 7. Switching Time Test Circuit & Waveforms



## 9. 订单信息 Order Information

- 零件编号 Part Number

### KL8171X(Z)-VG

#### Notes

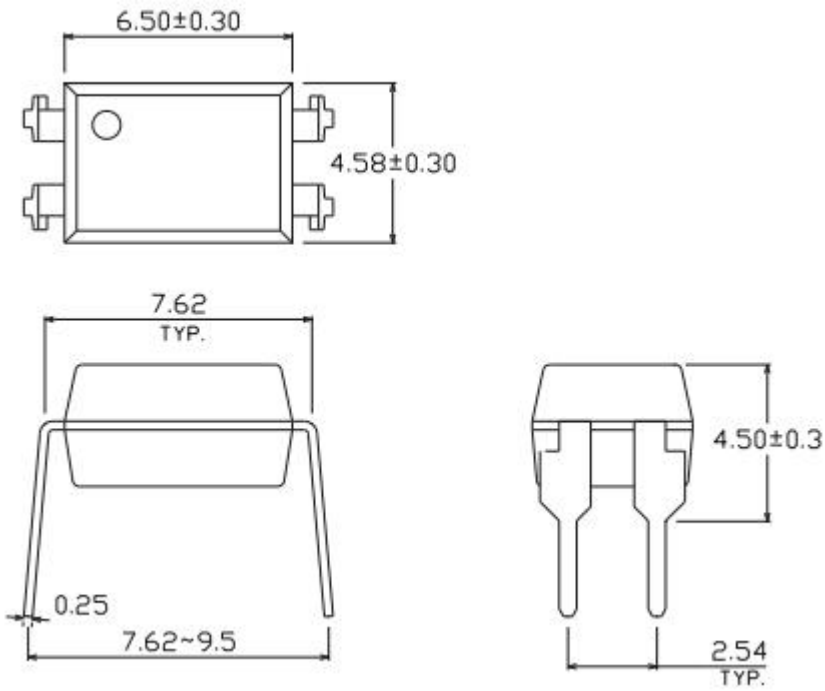
- X = 表示引脚形式选项(S、S1、M或无)  
Lead form option (S, S1, M or none)
- Z = 表示料带和卷盘选项(TA, TB, TU, TD or 无)  
Tape and reel option (TA, TB, TU, TD or none)
- V = 表示德国安规(可选) VDE (optional)
- G = 无卤素 Halogens free

选项 Option	描述 Description	包装数量 Packing quantity
直脚None	标准DIP-4 Standard DIP-4	每管100pcs 100 units per tube
M脚	折弯脚(0.4英寸间距) Wide lead bend (0.4 inch spacing)	每管100pcs 100 units per tube
S (TA)	表面贴装脚型方式+ TA料带 & 卷轴选择 Surface mount lead form + TA tape & reel option	每卷1000pcs 1000 units per reel
S (TB)	表面贴装脚型方式+ TB料带 & 卷轴选择 Surface mount lead form + TB tape & reel option	每卷1000pcs 1000 units per reel
S1 (TA)	表面贴装脚型方式(低轮廓)+ TA料带 & 卷轴选择 Surface mount lead form (low profile) + TA tape & reel option	每卷1000pcs 1000 units per reel
S1 (TB)	表面贴装脚型方式(低轮廓)+ TB料带 & 卷轴选择 Surface mount lead form (low profile) + TB tape & reel option	每卷1000pcs 1000 units per reel
S (TU)	表面贴装脚型方式+ TU料带 & 卷轴选择 Surface mount lead form + TU tape & reel option	每卷1500pcs 1500 units per reel
S (TD)	表面贴装脚型方式+ TD料带 & 卷轴选择 Surface mount lead form + TD tape & reel option	每卷1500pcs 1500 units per reel
S1 (TU)	表面贴装脚型方式(低轮廓)+ TU料带 & 卷轴选择 Surface mount lead form (low profile) + TU tape & reel option	每卷1500pcs 1500 units per reel
S1 (TD)	表面贴装脚型方式(低轮廓)+ TD料带 & 卷轴选择 Surface mount lead form (low profile) + TD tape & reel option	每卷1500pcs 1500 units per reel

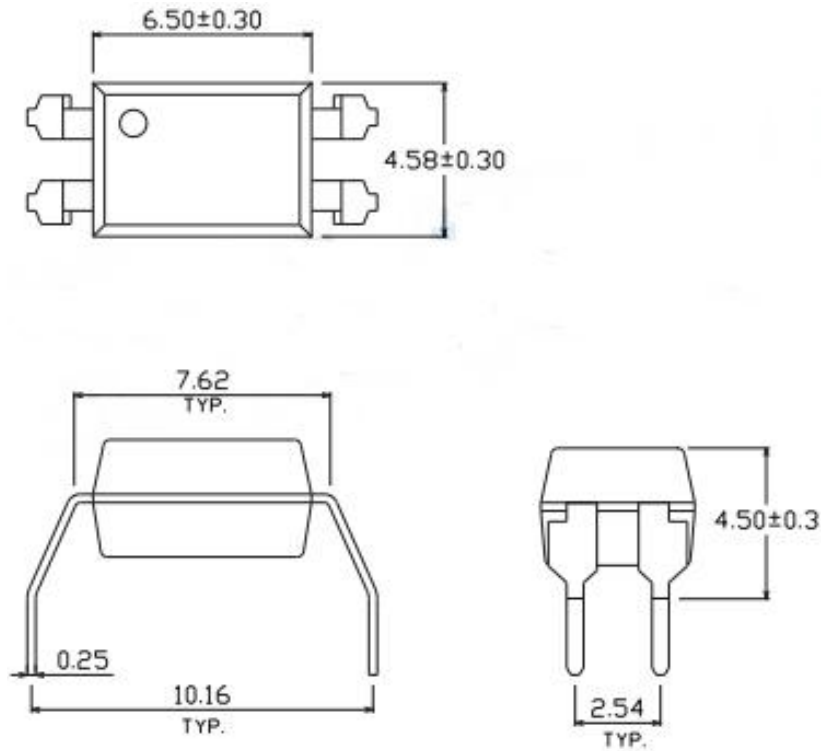


### 10. 封装尺寸(单位:毫米) Package Drawing(Unit:mm)

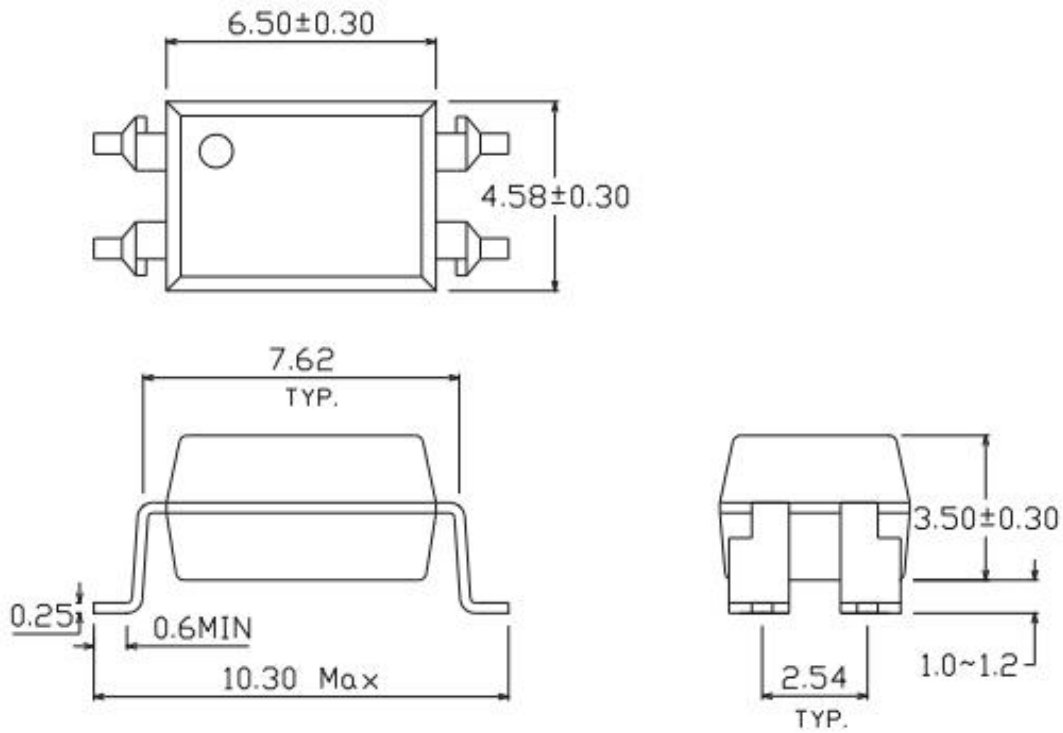
- 标准DIP型号 Standard DIP Type



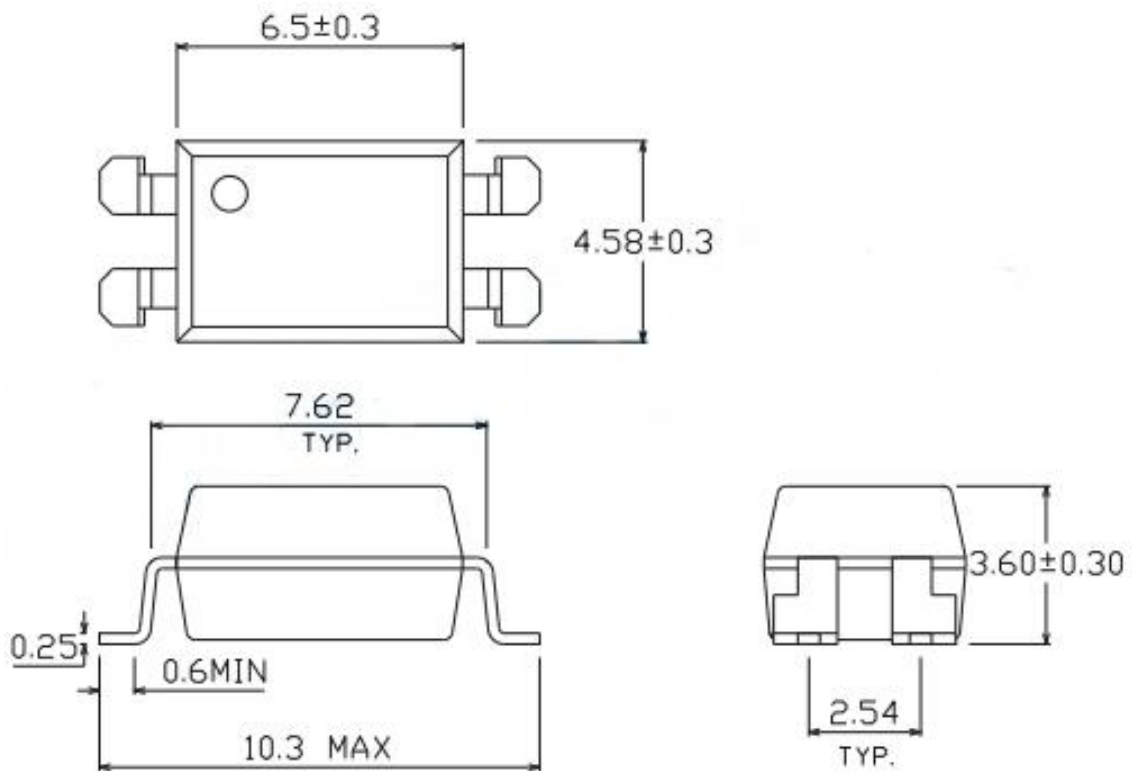
- 选择M型号 Option M Type



• 选择S型号 Option S Type

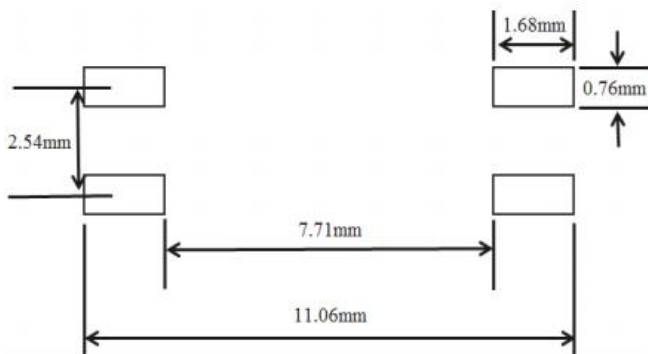


• 选择S1型号 Option S1 Type

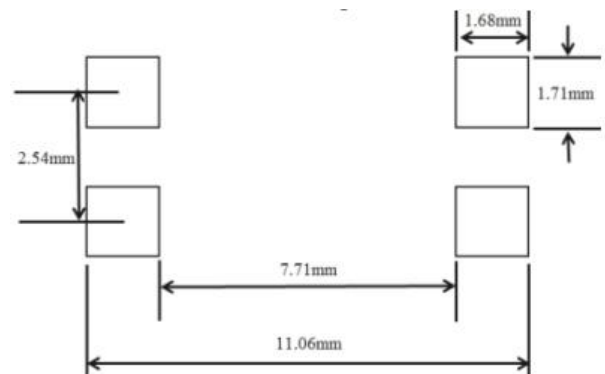


- 表面贴装引线框架 推荐焊盘布局 Recommended pad layout for surface mount leadform

S脚型焊盘 S Options



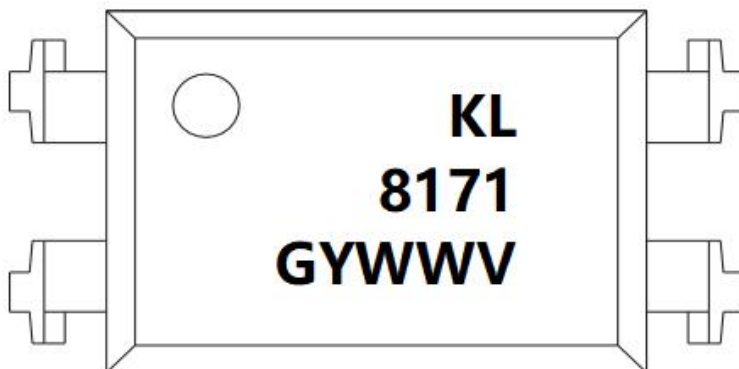
S1脚型焊盘 S1 Options



## 备注 Notes

- 建议焊盘尺寸仅供参考 Suggested pad dimension is just for reference only
- 请根据个人需要修改焊盘尺寸 Please modify the pad dimension based on individual need

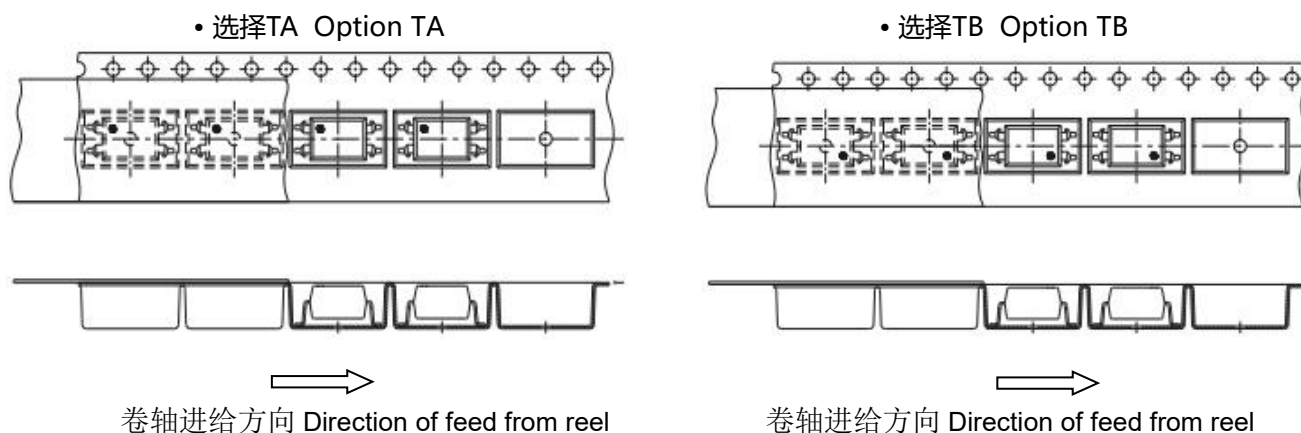
## 11. 设备标记 Device marking



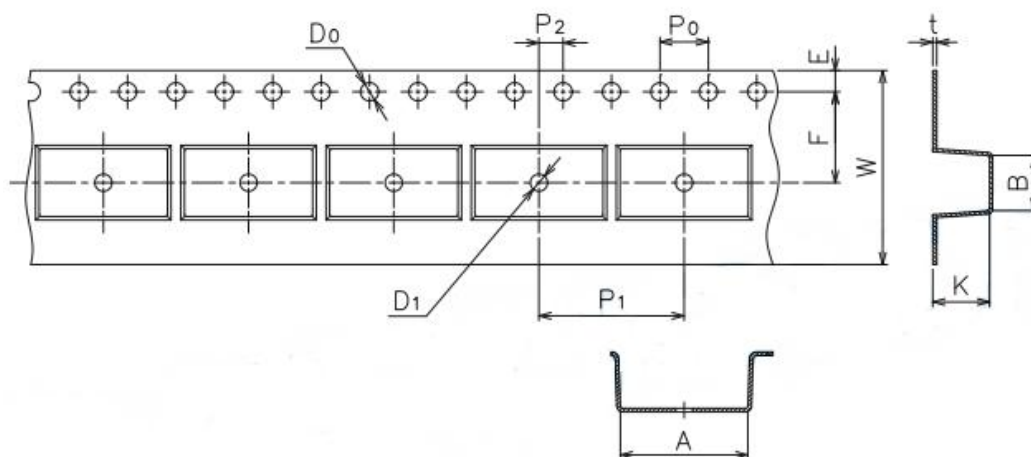
## 备注 Notes

- KL = 表示晶台光电有限公司 Denotes KingLight
- 8171 = 表示设备部件号 Denotes Device Part Number
- G = 表示环保材 Denotes Green part
- Y = 表示1位年份代码 Denotes 1 digit Year code
- WW = 表示2位周别代码 Denotes 2 digit Week code
- V = 表示VDE(可选) Denotes VDE (optional)

## 12. 料带和卷轴包装规格 Tape & Reel Packing Specifications



### 料带尺寸 Material belt size



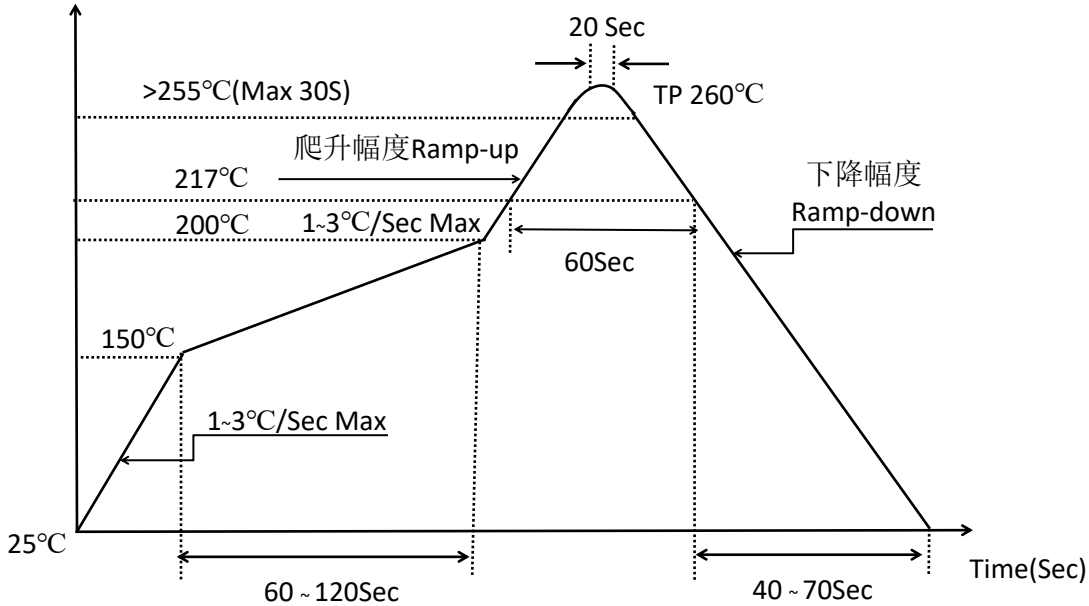
尺寸编号 Dimension No.	A	B	D0	D1	E	F
S尺寸(mm) S Dimension(mm)	10.7±0.1	4.65±0.1	1.5±0.1	1.5±0.1	1.75±0.1	7.5±0.1
S1尺寸(mm) S1 Dimension(mm)	10.7±0.1	4.65±0.1	1.5±0.1	1.5±0.1	1.75±0.1	7.5±0.1
尺寸编号 Dimension No.	P0	P1	P2	t	W	K
S尺寸(mm) S Dimension(mm)	4.0±0.1	12.0±0.1	2.0±0.1	0.4±0.1	16.0±0.3	4.75±0.1
S1尺寸(mm) S1 Dimension(mm)	4.0±0.1	12.0±0.1	2.0±0.1	0.4±0.1	16.0±0.3	3.90±0.1

### 13. 焊接温度曲线 Temperature Profile Of Soldering

#### • 回流焊温度曲线 Reflow soldering

建议在下面所示的温度和时间分布条件下, 进行一次回流焊作业, 不得超过三次

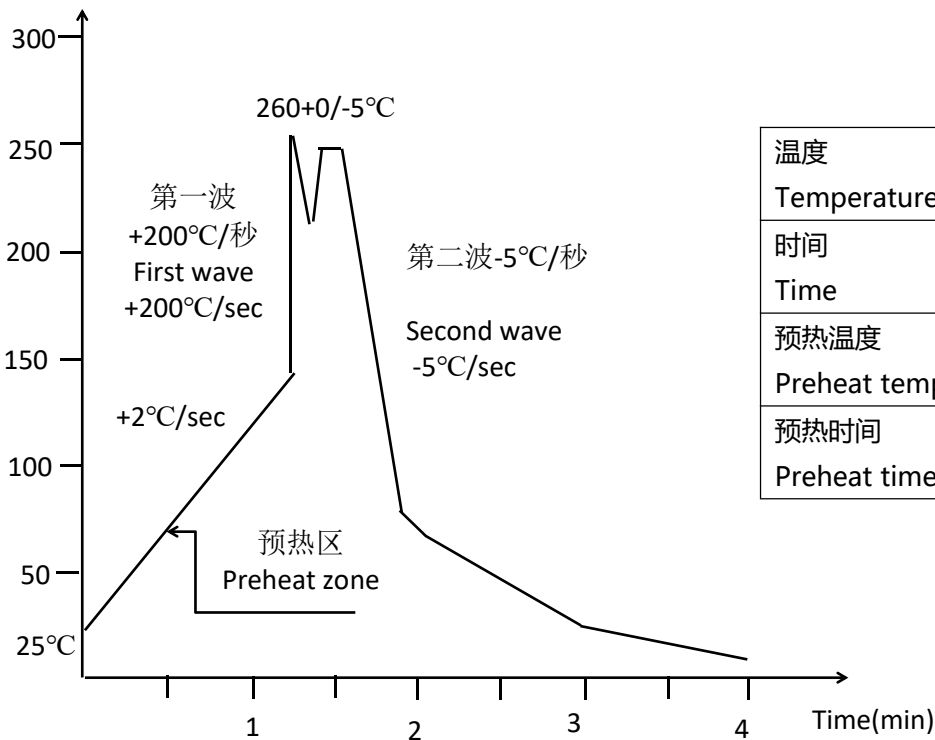
One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.



#### • 波峰焊温度曲线 Wave Soldering

温度条件下, 建议一次焊接

One time soldering is recommended within the condition of temperature



温度 Temperature	260°C+0/-5°C
时间 Time	10秒 10Sec
预热温度 Preheat temperature	25至140°C 25 to 140°C
预热时间 Preheat time	30至80秒 30 to 80 Sec